1N5823, 1N5824, 1N5825 (SILICON)

Designers Data Sheet

HOT CARRIER POWER RECTIFIERS

. employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State of the art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low vp
- Low Power Loss/High Efficiency
- Low Stored Charge, Majority
 Carrier Conduction
- High Surge Capacity

Designer's Data for "Worst Case" Conditions

The Designers Data sheets permit the design of most circuits entirely from the information presented. Limit curves – representing boundaries on device characteristics – are given to facilitate "worst case" design.

*MAXIMUM RATINGS

Rating	Symbol	1N5823	1N5824	1N5825	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	20	30	40	Volts
Non-Repetitive Peak Reverse Voltage	V _{RSM}	24	36	48	Volts
RMS Reverse Voltage	V _{R(RMS)}	14	21	28	Volts
Average Rectified Forward Current VR (equiv) $\leq 0.2 \text{ VR}$ (dc), T _C = 75°C VR (equiv) $\leq 0.2 \text{ VR}$ (dc), T _L = 80°C (R ₀ JA = 25°C/W, P.C. Board Mounting, See Note 3)	1 ₀	-	— 15 — — 5.0 —		Amp
Ambient Temperature Rated $V_R (dc)$, $P_{F(AV)} = 0$ $R_{\theta JA} = 25^{\circ}C/W$	ТА	65	60	55	°C
Non-Repetitive Peak Surge Current (surge applied at rated load condi- tions, halfwave, single phase 60 Hz)	¹ FSM	→ 500	(for 1 cyc	ele) —>	Amp
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	TJ,Tstg		65 to +129	-	°C
Peak Operating Junction Temperature (Forward Current Applied)	T _{J(pk)}	-	— 150 —		°C

*THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	oC/M

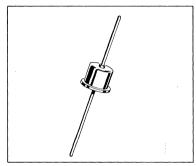
*ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted.)

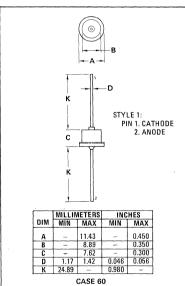
Characteristic	Symbol	1N5823	1N5824	1N5825	Unit
Maximum Instantanous Forward Voltage (1)	٧F				Volts
(IF = 3.0 Amp)	1	0.330	0.340	0.350	
(iF = 5.0 Amp)	1	0.360	0.370	0.380	
(i _F = 15.7 Amp)		0.470	0.490	0.520	ł
Maximum Instantanous Reverse	I _R				mA
Current @ rated dc Voltage	1		}		Ì
$T_C = 25^{\circ}C$ $T_C = 100^{\circ}C$	1	10	10	10	l
$T_{\rm C} = 100^{\rm O}{\rm C}$	1	75	75	75	l

⁽¹⁾ Pulse Test Pulse Width = 300 µs, Duty Cycle = 2.0%.

SCHOTTKY BARRIER RECTIFIERS

5 AMPERE 20, 30, 40 VOLTS





MECHANICAL CHARACTERISTICS

CASE: Welded, hermetically sealed construction. FINISH: All external surfaces corrosion-resistant and the terminal leads are readily solderable.

POLARITY: Cathode to case.

MOUNTING POSITIONS: Any

^{*}Indicates JEDEC Registered Data.

NOTE 1: DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above 0.1 VRWM. Proper derating may be accomplished by use of equation (1):

 $T_{A(max)} = T_{J(max)} - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)}$

TA(max) = Maximum allowable ambient temperature

T_J(max) = Maximum allowable junction temperature (125°C or the temperature at which thermal runaway occurs, whichever is lowest).

 $P_{E(\Delta V)} = Average forward power dissipation$

PR(AV) = Average reverse power dissipation

 $R_{\theta}JA$ = Junction-to-ambient thermal resistance

Figures 1, 2 and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2):

$$T_{R} = T_{J(max)} - R_{\theta JA} P_{R(AV)}$$
 (2)

Substituting equation (2) into equation (1) yields

$$T_{A(max)} = T_{R} - R_{\theta JA} P_{F(AV)}$$
(3)

Inspection of equations (2) and (3) reveals that TR is the ambient temperature at which thermal runaway occurs or where T₁ = 125°C, when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2 and 3 as a difference in the rate of change of the slope in the vicinity of 115°C. The data of Figures 1, 2 and 3 is based upon dc conditions. For use in common rectifier circuits, Table I indicates suggested factors for an equivalent dc voltage to use for conservative design: i.e.:

 $V_{R(equiv)} = V_{IN(PK)} \times F$

The Factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

Example: Find TA(max) for 1N5825 operated in a 12-Volt dc supply using a bridge circuit with capacitive filter such that I_{DC} = 10 A ($I_{F(AV)}$ = 5 A), $I_{(PK)}/I_{(AV)}$ = 10, Input Voltage = 10 V(rms), $R_{\theta,JA}$ = 10°C/W.

Find VR(equiv). Read F = 0.65 from Table I .. Sten 1: $V_{R(equiv)} = (1.41)(10)(0.65) = 9.2 V$

Find T_R from Figure 3. Read $T_R = 118^{\circ}C @ V_R =$

9.2 V & $R_{\theta JA} = 10^{\circ}$ C/W. Find $P_{F(AV)}$ from Figure 4. †Read $P_{F(AV)} = 5.5$ W Step 3: @ (PK) = 10 & IF(AV) = 5 A I(AV)

Find $T_{A(max)}$ from equation (3). $T_{A(max)} = 118-(10)$ (5.5) = 63°C. Step 4:

†Values given are for the 1N5825. Power is slightly lower for the other units because of their lower forward voltage

TABLE I - VALUES FOR FACTOR F

Circuit	Half	Half Wave		Full Wave, Bridge		Wave, pped ^{(1),(2)}
Load	Resistive	Capacitive (1)	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

(1) Note that V_{R(PK)}≈2 V_{in(PK)}

(2)Use line to center tap voltage for Vin.

FIGURE 1 - MAXIMUM REFERENCE TEMPERATURE - 1N5823

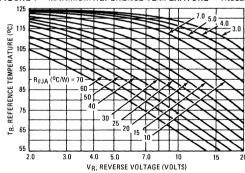


FIGURE 3 - MAXIMUM REFERENCE TEMPERATURE - 1N5825

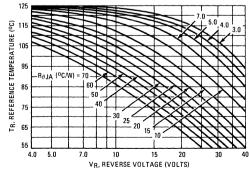


FIGURE 2 - MAXIMUM REFERENCE TEMPERATURE - 1N5824

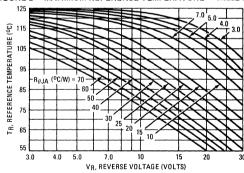
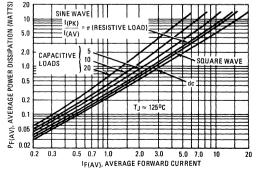
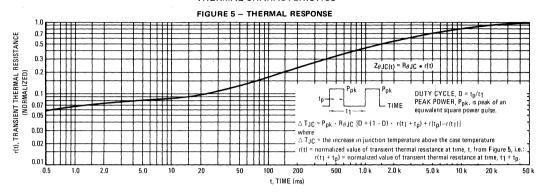


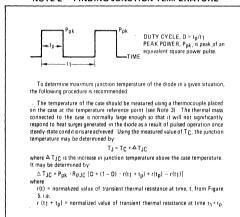
FIGURE 4 -- FORWARD POWER DISSIPATION



THERMAL CHARACTERISTICS



NOTE 2 - FINDING JUNCTION TEMPERATURE

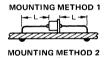


NOTE 3 - MOUNTING DATA

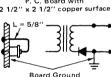
Data shown for thermal resistance junction-to-ambient $(R_{ heta JA})$ for the mountings shown is to be used as typical guideline values for preliminary engineering.

TYPICAL VALUES FOR $R_{\theta,JA}$ IN STILL AIR

	LEAD LENG		
MOUNTING METHOD	1/4	1	$R_{ heta JA}$
1	55	60	°C/W
2	65	70	°C/W
3	25		°C/W



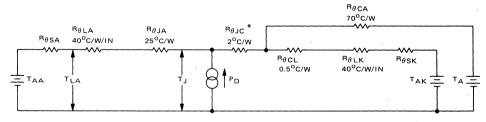






Vector pin mounting

FIGURE 6 - APPROXIMATE THERMAL CIRCUIT MODEL



Use of the above model permits calculation of average junction temperature for any mounting situation. Lowest values of thermal resistance will occur when the cathode lead is brought as close as possible to a heat dissipator; as heat conduction through the anode lead is small. Terms in the model are defined as follows:

*Case temperature reference is at cathode end.

TEMPERATURES

TA = Ambient

TAA = Anode Heat Sink Ambient

TAK = Cathode Heat Sink Ambient

T_{LA} = Anode Lead

 T_{LK} = Cathode Lead T_J = Junction

THERMAL RESISTANCES

 $R_{\theta CA} = Case to Ambient$

 $R_{\theta SA}$ = Anode Lead Heat Sink to Ambient ROSK = Cathode Lead Heat Sink to Ambient

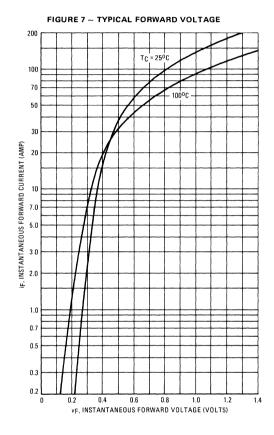
R₀LA = Anode Lead

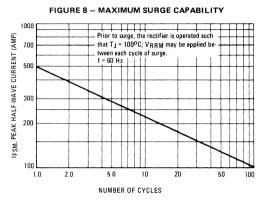
 $R_{\theta LK}$ = Cathode Lead

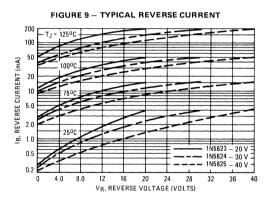
 $R_{\theta CL}$ = Case to Cathode Lead

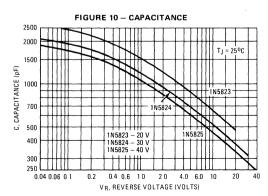
 $R_{\theta JC}$ = Junction to Case

 $R_{\theta JA} = Junction to Anode Lead (S bend)$









NOTE 4 - HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10).

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 per cent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.